

UTC UNISONIC TECHNOLOGIES CO., LTD

4N60K-MK **Preliminary**

Power MOSFET

4A, 600V N-CHANNEL **POWER MOSFET**

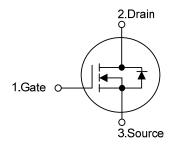
DESCRIPTION

The UTC 4N60K-MK is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)}$ < 2.5 Ω @ V_{GS} = 10 V
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, high Ruggedness

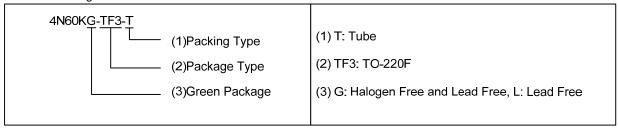
SYMBOL



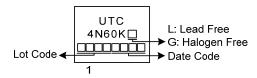
ORDERING INFORMATION

Ordering Number		Daalaaaa	Pin Assignment			Da alsim m	
Lead Free	Halogen Free	Package	1	2	3	Packing	
4N60KL-TF3-T	4N60KG-TF3-T	TO-220F	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



TO-220F

www.unisonic.com.tw 1 of 6

■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V _{DSS}	600	V	
Gate-Source Voltage		V _{GSS}	±30	V	
Avalanche Current (Note 2)		I _{AR}	4.4	Α	
Drain Current	Continuous	I _D	4.0	Α	
	Pulsed (Note 2)	I _{DM}	16	Α	
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	160	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
Power Dissipation		Б	36	W	
Derate above 25°C		P_D	0.288	W/°C	
Junction Temperature		TJ	+150	°C	
Operating Temperature		T _{OPR}	-55 ~ +150	°C	
Storage Temperature		T _{STG}	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 20mH, I_{AS} = 4A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 4. I_{SD}≤4.4A, di/dt ≤200A/µs, V_{DD}≤BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	θја	62.5	°C/W	
Junction to Case	θјс	3.47	°C/W	

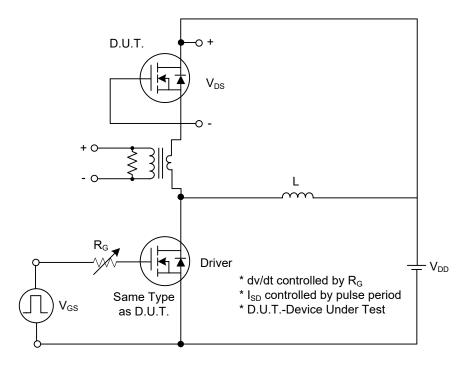
■ **ELECTRICAL CHARACTERISTICS** (T_C =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	600			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} =600V, V _{GS} =0V			10	μA	
			V _{DS} =600V, V _{GS} =0V, T _C =125°C			10	μA	
Gate-Source Leakage Current	Forward		V _{GS} =30V, V _{DS} =0V			100	nA	
	Reverse	I_{GSS}	V _{GS} = -30V, V _{DS} =0V			-100	nA	
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_{J}$	I _D =250μA,Referenced to 25°C		0.6		V/°C	
ON CHARACTERISTICS								
Gate Threshold Voltage		$V_{GS(TH)}$	V _{DS} =V _{GS} , I _D =250μA	2.5		4.5	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10 V, I _D =2.2A			2.5	Ω	
DYNAMIC CHARACTERISTICS								
Input Capacitance		Ciss	\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		477	575	pF	
Output Capacitance		Coss	$V_{DS} = 25V, V_{GS} = 0V,$		50	75	pF	
Reverse Transfer Capacitance		Crss	f = 1MHz		5.82	11	рF	
SWITCHING CHARACTERISTIC								
Turn-On Delay Time		t _{D(ON)}			45		ns	
Turn-On Rise Time		t _R	$V_{DD} = 300V, I_D = 4.0A,$		38		ns	
Turn-Off Delay Time		t _{D(OFF)}	R _G = 25Ω (Note 1, 2)		98		ns	
Turn-Off Fall Time		t _F			30		ns	
Total Gate Charge		\mathbf{Q}_{G}	14 4001/1 4.04		17.7		nC	
Gate-Source Charge		Q _{GS}	V _{DS} = 480V,I _D = 4.0A,		6		nC	
Gate-Drain Charge		Q_{GD}	V _{GS} = 10V (Note 1, 2)		3		nC	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Drain-Source Diode Forward Voltage		V_{SD}	V _{GS} = 0V, I _S = 4.4A			1.4	V	
Maximum Continuous Drain-Source Diode		Is				4.4	Α	
Forward Current						4.4	A	
Maximum Pulsed Drain-Source Diode		Іѕм				17.6	Α	
Forward Current						17.0	^	

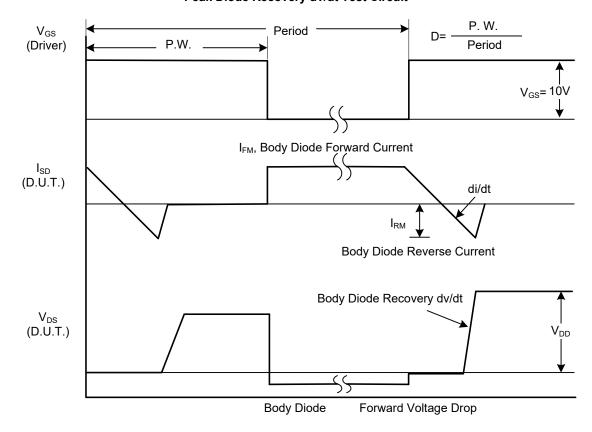
Notes: 1. Pulse Test: Pulse width≤300µs, Duty cycle≤2%

^{2.} Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

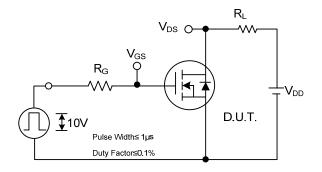


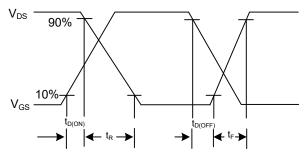
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

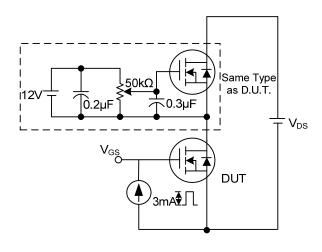
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

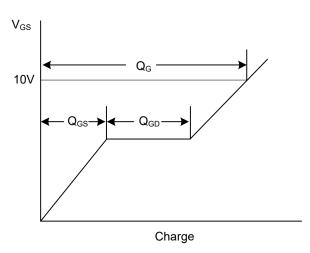




Switching Test Circuit

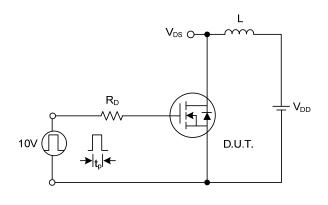
Switching Waveforms

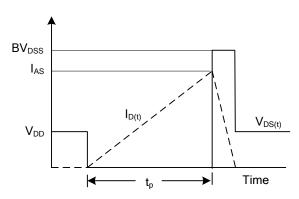




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

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